



1 Mbit (64Kb x16, Block Erase) Single Supply Flash Memory

- 5V±10% SUPPLY VOLTAGE for PROGRAM, ERASE and READ OPERATIONS
- FASTACCESS TIME: 55ns
- FAST PROGRAMMING TIME: 10µs typical
- PROGRAM/ERASE CONTROLLER (P/E.C.)
 - Program Word-by-Word
 - Status Register bits
- MEMORY BLOCKS
 - Boot Block (Bottom location)
 - Parameter and Main blocks
- BLOCK, MULTI-BLOCK and CHIP ERASE
- MULTI-BLOCK PROTECTION/TEMPORARY UNPROTECTION MODES
- ERASE SUSPEND and RESUME MODES
 - Read and Program another Block during Erase Suspend
- LOW POWER CONSUMPTION
 - Stand-by and Automatic Stand-by
- 100,000 PROGRAM/ERASE CYCLES per BLOCK
- ELECTRONIC SIGNATURE
 - Manufacturer Code: 0020h
 - Device Code: 0087h

Table 1. Signal Names

| A0-A15 | Address Inputs | | | |
|-----------------|------------------------------------|--|--|--|
| DQ0-DQ7 | Data Input/Outputs, Command Inputs | | | |
| DQ8-DQ15 | Data Input/Outputs | | | |
| Ē | Chip Enable | | | |
| G | Output Enable | | | |
| W | Write Enable | | | |
| V _{CC} | Supply Voltage | | | |
| V _{SS} | Ground | | | |

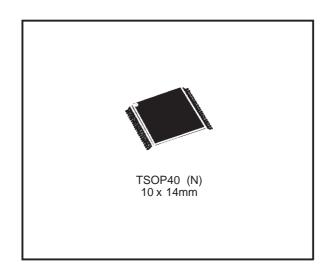
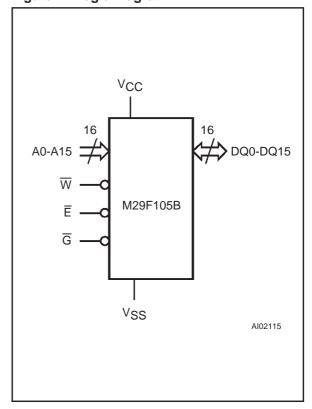


Figure 1. Logic Diagram



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Table 2. Absolute Maximum Ratings (1)

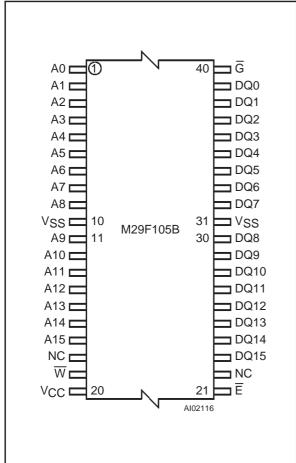
| Symbol | Parameter | Value | Unit |
|---|-----------------------------------|--------------|------|
| T _A | Ambient Operating Temperature (3) | -40 to 85 | °C |
| T _{BIAS} | Temperature Under Bias | -50 to 125 | °C |
| T _{STG} | Storage Temperature | -65 to 150 | °C |
| Vio (2) | Input or Output Voltages | -0.6 to 7 | V |
| V _{CC} | Supply Voltage | -0.6 to 7 | V |
| V _(A9, \overline{E}, \overline{G}) (2) | A9, E, G Voltage | -0.6 to 13.5 | V |

Notes: 1. Except for the rating "Operating Temperature Range", stresses above those listed in the Table "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

2. Minimum Voltage may undershoot to –2V during transition and for less than 20ns.

3. Depends on range.

Figure 2. TSOP Pin Connections



Warning: NC = Not Connected.

DESCRIPTION

The M29F105B is a non-volatile memory that may be erased electrically at the block or chip level and programmed in-system on a Word-by-Word basis using only a single 5V Vcc supply. Word programming takes typically $20\mu s$. For Program and Erase operations the necessary high voltages are generated internally. The device can also be programmed in standard programmers.

The array matrix organisation allows each block to be erased and reprogrammed without affecting other blocks. Blocks can be protected against programing and erase on programming equipment and in the application. They can also be temporarily unprotected. Each block can be programmed and erased over 100,000 cycles.

Block erase is performed in typically 1.0 second for the main blocks.

Instructions for Read/Reset, Auto Select for reading the Electronic Signature or Block Protection status, Programming, Block and Chip Erase, Erase Suspend and Resume Block Protect and Blocks Unprotect are written to the device in cycles of commands to a Command Interface using standard microprocessor write timings.

The device is offered in TSOP40 (10 x 14mm) packages.

Organisation

The M29F105B is organised as 64K x16 bits. The memory uses the address inputs A0-A15 and the Data Input/Outputs DQ0-DQ15. Memory control is provided by Chip Enable \overline{E} , Output Enable \overline{G} and Write Enable \overline{W} inputs.

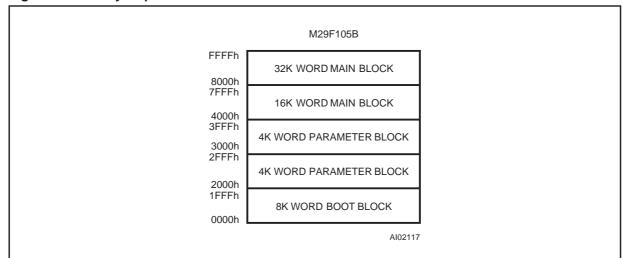


Figure 3. Memory Map and Block Address Table

Table 3. M29F105B Block Address Table

| Address Range | A15 | A14 | A13 | A12 |
|---------------|-----|-----|-----|-----|
| 0000h-1FFFh | 0 | 0 | 0 | Х |
| 2000h-2FFFh | 0 | 0 | 1 | 0 |
| 3000h-3FFFh | 0 | 0 | 1 | 1 |
| 4000h-7FFFh | 0 | 1 | X | Х |
| 8000h-FFFFh | 1 | Х | Х | Х |

Erase and Program operations are controlled by an internal Program/Erase Controller (P/E.C.). Status Register data output on DQ7 provides a Data Polling signal, and DQ6 and DQ2 provide Toggle signals to indicate the state of the P/E.C operations.

Memory Blocks

The devices feature asymmetrically blocked architecture providing system memory integration. The M29F105B device has an array of 5 blocks, one Boot Block of 8K Words, two Parameter Blocks of 4K Words, one Main Block of 16K Words and one Main Blocks of 32K Words. The M29F105B locates the Boot Block starting at the bottom of the memory address space. The memory map is shown in Figure 3. Each block can be erased separately, any combination of blocks can be specified for multiblock erase or the entire chip may be erased. The Erase operations are managed automatically by the P/E.C. The block erase operation can be suspended in order to read from or program to any block not being erased, and then resumed. Block protection provides additional data security. Each block can be separately protected or unprotected

against Program or Erase on programming equipment.

Bus Operations

The following operations can be performed using the appropriate bus cycles: Read (Array, Electronic Signature, Block Protection Status), Write command, Output Disable, Standby, Reset, Block Protection, Unprotection, Protection Verify and Unprotection Verify. See Tables.

Command Interface

Instructions, made up of commands written in cycles, can be given to the Program/Erase Controller through a Command Interface (C.I.). For added data protection, program or erase execution starts after 4 or 6 cycles. The first, second, fourth and fifth cycles are used to input Coded cycles to the C.I. This Coded sequence is the same for all Program/Erase Controller instructions. The 'Command' itself and its confirmation, when applicable, are given on the third, fourth or sixth cycles. Any incorrect command or any improper command sequence will reset the device to Read Array mode.

Instructions

Ten instructions are defined to perform Read Array, Auto Select (to read the Electronic Signature or Block Protection Status), Program, Block Protect, Blocks Unprotect, Block Erase, Chip Erase, Erase Suspend and Erase Resume. The internal P/E.C. automatically handles all timing and verification of the Program and Erase operations. The Status Register Data Polling, Toggle and Error bits may be read at any time, during programming or erase, to monitor the progress of the operation.

Instructions are composed of up to six cycles. The first two cycles input a Coded sequence to the Command Interface which is common to all instructions (see Table 9). The third cycle inputs the instruction set-up command. Subsequent cycles output the addressed data, Electronic Signature or Block Protection Status for Read operations. In order to give additional data protection, the instructions for Program and Block or Chip Erase require further command inputs. For a Program instruction, the fourth command cycle inputs the address and data to be programmed. For an Erase instruction (Block or Chip), the fourth and fifth cycles input a further Coded sequence before the command confirmation on the sixth cycle. Erasure of a memory block may be suspended, in order to read data from another block or to program data in another block, and then resumed.

The Block Protect and Blocks Unprotect commands allow these operations to be performed in the application. They provide a six cycle command access of the equivalent bus operations. This enables updates of the memory protected blocks in the field, without the use of a programmer or the need to generate 12V on the application.

When power is first applied or if V_{CC} falls below V_{LKO} , the command interface is reset to Read Array.

SIGNAL DESCRIPTIONS

See Figure 1 and Table 1.

Address Inputs (A0-A15). The address inputs for the memory array are latched during a write operation on the falling edge of Chip Enable \overline{E} or Write Enable \overline{W} . When A9 is raised to V_{ID} , either a Read Electronic Signature Manufacturer or Device Code, Block Protection Status or a Write Block Protection or Block Unprotection is enabled depending on the combination of levels on A0, A1 A6, A12 and A15.

Data Input/Outputs (DQ0-DQ15). The input is data to be programmed in the memory array or a command to be written to the C.I. Both are latched on the rising edge of Chip Enable E or Write Enable W. The output is data from the Memory Array, the

Electronic Signature Manufacturer or Device codes, the Block Protection Status or the Status register Data Polling bit DQ7, the Toggle Bits DQ6 and DQ2, the Error bit DQ5 or the Erase Timer bit DQ3. Outputs are valid when Chip Enable \overline{E} and Output Enable \overline{G} are active. The output is high impedance when the chip is deselected or the outputs are disabled and when \overline{RPNC} is at a Low level

Chip Enable ($\overline{\mathbf{E}}$). The Chip Enable input activates the memory control logic, input buffers, decoders and sense amplifiers. $\overline{\mathbf{E}}$ High deselects the memory and reduces the power consumption to the standby level. $\overline{\mathbf{E}}$ can also be used to control writing to the command register and to the memory array, while $\overline{\mathbf{W}}$ remains at a low level. The Chip Enable must be forced to V_{ID} during the Block Unprotection operation

Output Enable (\overline{\mathbf{G}}). The Output Enable gates the outputs through the data buffers during a read operation. When $\overline{\mathbf{G}}$ is High the outputs are High impedance. $\overline{\mathbf{G}}$ must be forced to V_{ID} level during Block Protection and Unprotection operations.

Write Enable (W). This input controls writing to the Command Register and Address and Datalatches.

Vcc Supply Voltage. The power supply for all operations (Read, Program and Erase).

 V_{SS} Ground. V_{SS} is the reference for all voltage measurements.

DEVICE OPERATIONS

See Tables 4, 5 and 6.

Read. Read operations are used to output the contents of the Memory Array, the Electronic Signature, the Status Register or the Block Protection Status. Both Chip Enable E and Output Enable G must be low in order to read the output of the memory.

Write. Write operations are used to give Instruction Commands to the memory or to latch input data to be programmed. A write operation is initiated when Chip Enable \overline{E} is Low and Write Enable \overline{W} is Low with Output Enable \overline{G} High. Addresses are latched on the falling edge of \overline{W} or \overline{E} whichever occurs last. Commands and Input Data are latchedon the rising edge of \overline{W} or \overline{E} whichever occurs first.

Output Disable. The data outputs are high impedance when the Output Enable \overline{G} is High with Write Enable \overline{W} High.

Standby. The memory is in standby when Chip Enable E is High and the P/E.C. is idle. The power consumption is reduced to the standby level and the outputs are high impedance, independent of the Output Enable G or Write Enable W inputs.

Table 4. User Bus Operations (1)

| Operation | Ē | G | w | Α0 | A 1 | A6 | A9 | A12 | A15 | DQ0-DQ15 |
|--|-----------------|-----------------|-----------------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------------------|
| Read Word | V_{IL} | V _{IL} | V _{IH} | A0 | A1 | A6 | A9 | A12 | A15 | Data Output |
| Write Word | V _{IL} | V _{IH} | V _{IL} | A0 | A1 | A6 | A9 | A12 | A15 | Data Input |
| Output Disable | V _{IL} | V _{IH} | V _{IH} | Х | Х | Х | Х | Х | Х | Hi-Z |
| Standby | V _{IH} | Х | Х | Х | Х | Х | Х | Х | Х | Hi-Z |
| Reset | Х | Х | Х | Х | Х | Х | Х | Х | Х | Hi-Z |
| Block Protection ⁽²⁾ | V_{IL} | V _{ID} | V _{IL} Pulse | X | Х | Х | V _{ID} | Х | Х | Х |
| Blocks Unprotection | V _{ID} | V _{ID} | V _{IL} Pulse | X | X | Х | V _{ID} | V _{IH} | V _{IH} | Х |
| Block Protection Verify ^(2,4) | V _{IL} | V _{IL} | V _{IH} | V _{IL} | V _{IH} | V _{IL} | V _{ID} | A12 | A15 | Block Protect Status (3) |
| Block Unprotection Verify ^(2,4) | V _{IL} | VıL | V _{IH} | V _{IL} | V _{IH} | V _{IH} | V _{ID} | A12 | A15 | Block Protect Status (3) |

Notes: 1. $X = V_{IL}$ or V_{IH}

2. Block Address must be given on A12-A15 bits.

3. See Table 6.

4. Operation performed on programming equipment.

Table 5. Read Electronic Signature (following AS instruction or with A9 = V_{ID})

| Code | Ē | G | w | Α0 | A1 Other Addresses | | DQ8-DQ15 | DQ0-DQ7 |
|----------------|----------|-----------------|-----------------|-----------------|--------------------|------------|----------|---------|
| Manufact. Code | V_{IL} | V _{IL} | V _{IH} | V_{IL} | V_{IL} | Don't Care | 00h | 20h |
| Device Code | V_{IL} | V _{IL} | V _{IH} | V _{IH} | V _{IL} | Don't Care | 00h | 87h |

Table 6. Read Block Protection with AS Instruction

| Code | Ē | G | w | Α0 | A1 | A12-A15 | Other Addresses | DQ0-DQ7 |
|-------------------|-----------------|-----------------|-----------------|-----------------|-----------------|---------------|--------------------|---------|
| Protected Block | V _{IL} | V _{IL} | V _{IH} | V _{IL} | V _{IH} | Block Address | Don't Care | 01h |
| Unprotected Block | V _{IL} | V _{IL} | V _{IH} | V _{IL} | V _{IH} | Block Address | Don't Care | 00h |

Automatic Standby. After 150ns of bus inactivity and when CMOS levels are driving the addresses, the chip automatically enters a pseudo-standby mode where consumption is reduced to the CMOS standby value, while outputs still drive the bus.

Electronic Signature. Two codes identifying the manufacturer and the device can be read from the memory. The manufacturer's code for STMicroelectronics is 20h, the device code is 87h. These codes allow programming equipment or applications to automatically match their interface to the

characteristics of the M29F105B. The Electronic Signature is output by a Read operation when the voltage applied to A9 is at $V_{\rm ID}$ and address inputs A1 is Low. The manufacturer code is output when the Address input A0 is Low and the device code when this input is High. Other Address inputs are ignored. The codes are output on DQ0-DQ7. This is shown in Table 4.

The Electronic Signature can also be read, without raising A9 to V_{ID} , by giving the memory the Instruction AS. The codes are output on DQ0-DQ7 with DQ8-DQ15 at 00h.

Block Protection. Each block can be separately protected against Program or Erase on programming equipment. Block protection provides additional data security, as it disables all program or erase operations. This mode is activated when both A9 and \overline{G} are raised to V_{ID} and an address in the block is applied on A12-A15. The Block Protection algorithm is shown in Figure 14. Block protection is initiated on the edge of \overline{W} falling to V_{IL} . Then after a delay of 100 μ s, the edge of \overline{W} rising to V_{IH} ends the protection operations. Block protection verify is achieved by \underline{br} inging \overline{G} , \overline{E} , A0 and A6 to V_{IL} and A1 to V_{IH} , while \overline{W} is at V_{IH} and A9 at V_{ID} . Under these conditions, reading the data output will yield 01h if the block defined by the inputs on A12-A15 is protected. Any attempt to program or erase a protected block will be ignored by the device. The blocks can also be protected without the use of V_{ID} , by giving to the memory the instruction BP (see Table 9).

Block Unprotection. All protected blocks can be unprotected on programming equipment to allow updating of bit contents. All blocks must first be protected before the unprotection operation. Block unprotection is activated when A9, \overline{G} and \overline{E} are at V_{ID} and A12, A15 at V_{IH}. The Block Unprotection algorithm is shown in Figure 15. Unprotection is initiated by the edge of \overline{W} falling to V_{IL} . After a delay of 10ms, the unprotection operation will end. Unprotection verify is achieved by bringing G and E to V_{IL} while A0 is at V_{IL} , A6 and A1 are at V_{IH} and A9 remains at V_{ID}. In these conditions, reading the output data will yield 00h if the block defined by the inputs A12- A15 has been succesfully unprotected. Each block must be separately verified by giving its address in order to ensure that it has been unprotected. The blocks can also be unprotected without the use of V_{ID}, by giving to the memory the instruction BU (see Table 9).

INSTRUCTIONS AND COMMANDS

The Command Interface latches commands written to the memory. Instructions are made up from one or more commands to perform Read Memory Array, Read Electronic Signature, Read Block Protection, Program, Block Protect, Blocks Unprotect, Block Erase, Chip Erase, Erase Suspend and Erase Resume. Commands are made of address and data sequences. The instructions require from 1 to 6 cycles, the first or first three of which are always write operations used to initiate the instruction. They are followed by either further write cycles to confirm the first command or execute the command immediately. Command sequencing must be followed exactly. Any invalid combination of commands will reset the device to Read Array. The

increased number of cycles has been chosen to assure maximum data security. Instructions are initialised by two initial Coded cycles which unlock the Command Interface. In addition, for Erase, instruction confirmation is again preceded by the two Coded cycles.

Status Register Bits

P/E.C. status is indicated during execution by Data Polling on DQ7, detection of Toggle on DQ6 and DQ2, or Error on DQ5 and Erase Timer DQ3 bits. Any read attempt during Program or Erase command execution will automatically output these five Status Register bits. The P/E.C. automatically sets bits DQ2, DQ3, DQ5, DQ6 and DQ7. Other bits (DQ0, DQ1 and DQ4) are reserved for future use and should be masked. See Tables 8 and 10.

Data Polling Bit (DQ7). When Programming operations are in progress, this bit outputs the complement of the bit being programmed on DQ7. During Erase operation, it outputs a '0'. After completion of the operation, DQ7 will output the bit last programmed or a '1' after erasing. Data Polling is valid and only effective during P/E.C. operation, that is after the fourth W pulse for programming or after the sixth W pulse for erase. It must be performed at the address being programmed or at an address within the block being erased. If all the blocks selected for erasure are protected, DQ7 will be set to '0' for about 100 µs, and then return to the previous addressed memory data value. See Figure 11 for the Data Polling flowchart and Figure 10 for the Data Polling waveforms. DQ7 will also flag the Erase Suspend mode by switching from '0' to '1' at the start of the Erase Suspend. In order to monitor DQ7 in the Erase Suspend mode an address within a block being erased must be provided. For a Read Operation in Erase Suspend mode, DQ7 will output '1' if the read is attempted on a block being erased and the data value on other blocks. During Program operation in Erase Suspend Mode, DQ7 will have the same behaviour as in the normal program execution outside of the suspend mode.

Toggle Bit (DQ6). When Programming or Erasing operations are in progress, successive attempts to read DQ6 will output complementary data. DQ6 will toggle following toggling of either \overline{G} , or \overline{E} when \overline{G} is low. The operation is completed when two successive reads yield the same output data. The next read will output the bit last programmed or a '1' after erasing. The toggle bit DQ6 is valid only during P/E.C. operations, that is after the fourth \overline{W} pulse for programming or after the sixth \overline{W} pulse for Erase. If the blocks selected for erasure are protected, DQ6 will toggle for about 100 μ s and then return back to Read. DQ6 will be set to '1' if a Read

Table 7. Commands

| Hex Code | Command | | |
|----------|---|--|--|
| 00h | Invalid/Reserved | | |
| 10h | Chip Erase Confirm | | |
| 20h | Reserved | | |
| 30h | Block Erase Resume/Confirm | | |
| 80h | Set-up Erase | | |
| 90h | Read Electronic Signature/ Block Protection Status | | |
| A0h | Program | | |
| B0h | Erase Suspend | | |
| F0h | Read Array/Reset | | |

operation is attempted on an Erase Suspend block. When erase is suspended DQ6 will toggle during programming operations in a block different to the block in Erase Suspend. Either \overline{E} or \overline{G} toggling will cause DQ6 to toggle. See Figure 12 for Toggle Bit flowchart and Figure 13 for Toggle Bit waveforms.

Toggle Bit (DQ2). This toggle bit, together with DQ6, can be used to determine the device status during the Erase operations. It can also be used to identify the block being erased. During Erase or Erase Suspend a read from a block being erased will cause DQ2 to toggle. A read from a block not being erased will set DQ2 to '1' during erase and to DQ2 during Erase Suspend. During Chip Erase a read operation will cause DQ2 to toggle as all blocks are being erased. DQ2 will be set to '1' during program operation and when erase is complete. After erase completion and if the error bit DQ5 is set to '1', DQ2 will toggle if the faulty block is addressed.

Error Bit (DQ5). This bit is set to '1' by the P/E.C. when there is a failure of programming, block erase, or chip erase that results in invalid data in the memory block. In case of an error in block erase or program, the block in which the error occured or to which the programmed data belongs, must be discarded. The DQ5 failure condition will also appear if a user tries to program a '1' to a location that is previously programmed to '0'. Other Blocks may still be used. The error bit resets after a Read/Reset (RD) instruction. In case of success of Program or Erase, the error bit will be set to '0'.

Erase Timer Bit (DQ3). This bit is set to '0' by the P/E.C. when the last block Erase command has been entered to the Command Interface and it is awaiting the Erase start. When the wait period is finished, after 50μs to 120μs, DQ3 returns to '1'.

Coded Cycles

The two Coded cycles unlock the Command Interface. They are followed by an input command or a confirmation command. The Coded cycles consist of writing the data AAh at address 555h during the first cycle. During the second cycle the Coded cycles consist of writing the data 55h at address AAAh. Address lines A0 to A11 are valid other address lines are 'don't care'. The Coded cycles happen on first and second cycles of the command write or on the fourth and fifth cycles.

Instructions

See Table 9.

Read/Reset (RD) Instruction. The Read/Reset instruction consists of one write cycle giving the command F0h. It can be optionally preceded by the two Coded cycles. Subsequentread operations will read the memory array addressed and output the data read. A wait state of 10µs is necessary after Read/Reset prior to any valid read if the memory was in an Erase mode when the RD instruction is given.

Auto Select (AS) Instruction. This instruction uses the two Coded cycles followed by one write cycle giving the command 90h to address 555h for command set-up. A subsequent read will output the manufacturer code and the device code or the block protection status depending on the levels of A0 and A1. The manufacturer code, 20h, is output when the addresses lines A0 and A1 are Low, the device code, 87h is output when A0 is High with A1 Low.

The AS instruction also allows access to the block protection status. After givingthe AS instruction, A0 and A6 are set to $\rm V_{IL}$ with A1 at $\rm V_{IH}$, while A12-A15 define the address of the block to be verified. A read in these conditions will output a 01h if the block is protected and a 00h if the block is not protected.

Table 8. Polling and Toggle Bits

| Mode | DQ7 | DQ6 | DQ2 | |
|--|-----|--------|--------|--|
| Program | DQ7 | Toggle | 1 | |
| Erase | 0 | Toggle | Note 1 | |
| Erase Suspend Read (in Erase Suspend block) | 1 | Toggle | | |
| Erase Suspend Read (outside Erase Suspend block) | DQ7 | DQ6 | DQ2 | |
| Erase Suspend Program | DQ7 | Toggle | N/A | |

Note: 1. Toggle if the address is within a block being erased.
'1' if the address is within a block not being erased.

Table 9. Instructions (1)

| Mne. | Instr. | Cyc. | | 1st Cyc. | 2nd Cyc. | 3rd Cyc. | 4th Cyc. | 5th Cyc. | 6th Cyc. | 7th Cyc. | |
|---------------------|----------------------|------|------------------------|----------|---|-------------|---|--------------------------|----------------------------------|------------------------------------|----------|
| | | 1+ | Addr. (3,7) | Х | Poad Mon | nory Array | until a new write cycle is initiated | | | | |
| RD ^(2,4) | Read/Reset Memory | '* | Data | F0h | Read Memory Array until a new write cycle is initiated. | | | | | | |
| | Array | 3+ | Addr. (3,7) | 555h | AAAh | 555h | Read Memory Array until a new write cycle | | | | |
| | | | Data | AAh | 55h | F0h | is initiated | | | | |
| AS ⁽⁴⁾ | S (4) Auto Select | ٠. | Addr. (3,7) | 555h | AAAh | 555h | | | ature or Bloo | | |
| A5 \ / | Auto Seiect | 3+ | Data | AAh | 55h | 90h | | Status uni See Note 5 | til a new write and 6. | e cycle is | |
| PG | Program | 4 | Addr. (3,7) | 555h | AAAh | 555h | Program Address | | a Polling or T | | |
| 10 | 1 Togram | 7 | Data | AAh | 55h | A0h | Program Data | until Program completes | | es. | |
| BP | BP Block Protect | - h | Addr. ^(3,7) | 555h | AAAh | 555h | 555h | AAAh | Block Address ⁽¹¹⁾ | | |
| | 1 101001 | | Data | AAh | 55h | 80h | AAh | 55h | 40h | | |
| BU | Blocks | 6 | Addr. (3,7) | 555h | AAAh | 555h | 555h | AAAh | 9041h | | |
| | Unprotect | | Data | AAh | 55h | 80h | AAh | 55h | 60h | | |
| BE | Block Erase | 6 | Addr. (3,7) | 555h | AAAh | 555h | 555h | AAAh | Block Address | Additional Block ⁽⁸⁾ | |
| | | | Data | AAh | 55h | 80h | AAh | 55h | 30h | 30h | |
| CE | Chip Erase | 6 | Addr. (3,7) | 555h | AAAh | 555h | 555h | AAAh | 555h | Note 9 | |
| OL. | Omp Lidoo | | Data | AAh | 55h | 80h | AAh | 55h | 10h | 14010 0 | |
| ES (10) | Erase | 1 | Addr. (3,7) | Х | | | | | data needed | from any | |
| | Suspend | | Data | B0h | Block(s) n | ot being er | ased then | Resume E | rase. | | |
| ER | Erase | e 1 | Erase 1 | | Х | | | | s until Eras | se completes | or Erase |
| | Resume | | Data | 30h | is suspended another time | | | | | | |

Notes: 1. Commands not interpreted in this table will default to read array mode.

- A wait of 10 µs is necessary after a Read/Reset command if the memory was in an Erase or Erase Suspend mode before starting any new operation.
- 3. X = Don't Care.
 4. The first cycles of the RD or AS instructions are followed by read operations. Any number of read cycles can occur after the command cycles.
- 5. Signature Addréss bits A0, A1, at VIL will output Manufacturer code (20h). Address bits A0 at VIH and A1, at VIL will output
- Block Protection Address: A0, at V_{IL}, A1 at V_{IH} and A12-A15 within the Block will output the Block Protection status.
 For Coded cycles address inputs A12-A15 are don't care.
 Optional, additional Blocks addresses must be entered within a 50μs delay after last write entry, timeout status can be verified through DQ3 value. When full command is entered, read Data Polling or Toggle bit until Erase is completed or suspended.
- 9. Read Data Polling, Toggle bits until Erase completes.
- 10.During Erase Suspend, Read and Data Program functions are allowed in blocks not being erased.

 11.Block Address must be given on A12-A15 while A6 and A1 are set to V_{IL}, and A0 is set to V_{IH}.

Table 10. Status Register Bits

| DQ | Name | Logic Level | Definition | Note |
|----|-------------------|----------------------------|---|--|
| | | '1' | Erase Complete or erase block in Erase Suspend | |
| 7 | Data | '0' | Erase On-going | Indicates the P/E.C. status, check during Program or Erase, and on completion |
| , | Polling | DQ | Program Complete or data of non erase block during Erase Suspend | before checking bits DQ5 for Program or Erase Success. |
| | | DQ | Program On-going | |
| | | '-1-0-1-0-1-' | Erase or Program On-going | Successive reads output complementary |
| 6 | Toggle Bit | DQ | Program Complete | data on DQ6 while Programming or Erase operations are on-going. DQ6 remains at |
| | roggio Bit | '-1-1-1-1-1-1-' | Erase Complete or Erase Suspend on currently addressed block | constant level when P/E.C. operations are completed or Erase Suspend is acknowledged. |
| 5 | Error Bit | '1' Program or Erase Error | | This bit is set to '1' in the case of |
| | '0' | | Program or Erase On-going | Programming or Erase failure. |
| 4 | Reserved | | | |
| 3 | Erase Time Bit | '1' | Erase Timeout Period Expired | P/E.C. Erase operation has started. Only possible command entry is Erase Suspend (ES). |
| | Time Bit | '0' | Erase Timeout Period On-going | An additional block to be erased in parallel can be entered to the P/E.C. |
| 2 | Toggle Bit | '-1-0-1-0-1-' | Chip Erase, Erase or Erase Suspend on the currently addressed block. Erase Error due to the currently addressed block (when DQ5 = '1'). | Indicates the erase status and allows to |
| | | 1 | Program on-going, Erase on-going on another block or Erase Complete | identify the erased block |
| | | DQ | Erase Suspend read on non Erase Suspend block | |
| 1 | Reserved | | | |
| 0 | Reserved | | | |

Notes: Logic level '1' is High, '0' is Low. -0-1-0-0-0-1-1-1-0- represent bit value in successive Read operations.

Program (PG) Instruction. This instruction uses four write cycles. The Program command A0h is written to address 555h on the third cycle after two Coded cycles. A fourth write operation latches the Address on the falling edge of \overline{W} or \overline{E} and the Data to be written on the rising edge and starts the P/E.C. Read operations output the Status Register bits after the programming has started. Memory

programming is made only by writing '0' in place of '1'. Status bits DQ6 and DQ7 determine if programming is on-going and DQ5 allows verification of any possible error. Programming at an address not in blocks being erased is also possible during erase suspend. In this case, DQ2 will toggle at the address being programmed.

Table 11. AC Measurement Conditions

| | High Speed | Standard |
|---------------------------------------|------------|---------------|
| Input Rise and Fall Times | ≤ 10ns | ≤ 10ns |
| Input Pulse Voltages | 0 to 3V | 0.45V to 2.4V |
| Input and Output Timing Ref. Voltages | 1.5V | 0.8V to 2V |

Figure 4. AC Testing Input Output Waveform

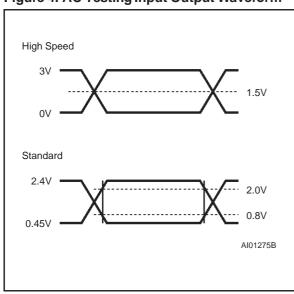


Figure 5. AC Testing Load Circuit

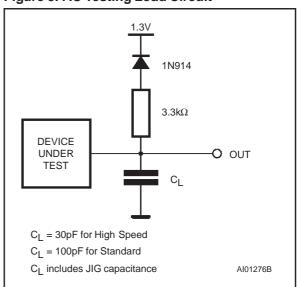


Table 12. Capacitance⁽¹⁾ $(T_A = 25 \, ^{\circ}C, f = 1 \, \text{MHz})$

| Symbol | Parameter Test Condition | | Min | Max | Unit |
|------------------|--------------------------|-----------------------|-----|-----|------|
| C _{IN} | Input Capacitance | $V_{IN} = 0V$ | | 6 | pF |
| C _{OUT} | Output Capacitance | V _{OUT} = 0V | | 12 | pF |

Note: 1. Sampled only, not 100% tested.

Block Protect (BP) Instruction. This instruction uses six write cycles. The Set-up command 80h is written to address 555h on the third cycle after the two Coded cycles. The Block Protect Confirm command 40h is similarly written on the sixth cycle after another two Coded cycles. During the input of the second command an address with A0 at V_{IH}, A1 and A6 at V_{IL}, and within the block to be protected is given and latched into the memory. The Block Protection algorithm flowchart is described in Figure 16.

Blocks Unprotect (BU) Instruction. This instruction uses six write cycles. The Set-up command 80h is written to address 555h on the third cycle

after the two Coded cycles. The Block Unprotect Confirm command 60h is similarly written to address 9041h after another two Coded cycles. The Blocks Unprotection alghrithm flowchart is described in Figure 17.

Block Erase (BE) Instruction. This instruction uses a minimum of six write cycles. The Set-up command 80h is written to address 555h on third cycle after the two Coded cycles. The Block Erase Confirm command 30h is similarly written on the sixth cycle after another two Coded cycles. During the input of the second command an address within the block to be erased is given and latched into the memory. Additional block Erase Confirm com-

Table 13. DC Characteristics

 $(T_A = 0 \text{ to } 70^{\circ}\text{C or } -40 \text{ to } 85^{\circ}\text{C}; V_{CC} = 5\text{V} \pm 10\%)$

| Symbol | Parameter | Test Condition | Min | Max | Unit |
|------------------|---|--|-----------------------|-----------------------|------|
| ILI | Input Leakage Current | $0V \le V_{IN} \le V_{CC}$ | | ±1 | μΑ |
| I _{LO} | Output Leakage Current | $0V \le V_{OUT} \le V_{CC}$ | | ±1 | μΑ |
| I _{CC1} | Supply Current (Read) TTL | $\overline{E} = V_{IL}, \overline{G} = V_{IH}, f = 6MHz$ | | 50 | mA |
| I _{CC2} | Supply Current (Standby) TTL | E = V _{IH} | | 1 | mA |
| I _{CC3} | Supply Current (Standby) CMOS | $\overline{E} = V_{CC} \pm 0.2V$ | | 100 | μΑ |
| I _{CC4} | Supply Current (Program or Erase) | Byte program, Block or Chip Erase in progress | | 20 | mA |
| V_{IL} | Input Low Voltage | | -0.5 | 0.8 | V |
| V_{IH} | Input High Voltage | | 2 | V _{CC} + 0.5 | V |
| V_{OL} | Output Low Voltage | I _{OL} = 5.8mA | | 0.45 | V |
| | Output High Voltage TTL | I _{OH} = -2.5mA | 2.4 | | V |
| V_{OH} | Output High Voltage CMOS | $I_{OH} = -100 \mu A$ | V _{CC} -0.4V | | V |
| | output riigii voitago oirioo | I _{OH} = -2.5mA | 0.85 V _{CC} | | V |
| V_{ID} | A9, E, G Voltage | | 11.5 | 12.5 | V |
| I _{ID} | A9, E, G Current | A9 = V _{ID} | | 100 | μΑ |
| V_{LKO} | Supply Voltage (Erase and Program lock-out) | | 3.2 | 4.2 | V |

mands and block addresses can be written subsequently to erase other blocks in parallel, without further Coded cycles. The erase will start after an erase timeout period of 80µs. Thus, additional Erase Confirm commands for other blocks must be given within this delay.

The input of a new Erase Confirm command will restart the timeout period. The status of the internal timer can be monitored through the level of DQ3, if DQ3 is '0' the Block Erase Command has been given and the timeout is running, if DQ3 is '1', the timeout has expired and the P/E.C. is erasing the Block(s). If the second command given is not an erase confirm or if the Coded cycles are wrong, the instruction aborts, and the device is reset to Read Array. It is not necessary to program the block with 0000h as the P/E.C. will do this automatically be-

fore to erasing to FFFFh. Read operations after the sixth rising edge of \overline{W} or \overline{E} output the status register status bits.

During the execution of the erase by the P/E.C., the memory accepts only the Erase Suspend ES and Read/Reset RD instructions. Data Polling bit DQ7 returns '0' while the erasure is in progress and '1' when it has completed. The Toggle bit DQ2 and DQ6 toggle during the erase operation. They stop when erase is completed. After completion the Status Register bit DQ5 returns '1' if there has been an erase failure. In such a situation, the Toggle bit DQ2 can be used to determine which block is not correctly erased. In the case of erase failure, a Read/Reset RD instruction is necessary in order to reset the P/E.C.

Table 14. Read AC Characteristics

 $(T_A = 0 \text{ to } 70^{\circ}\text{C or } -40 \text{ to } 85^{\circ}\text{C})$

| | | | | | | M29F | 105B | | | | | |
|-----------------------|------------------|--|--|-------------------------|--------|------|---------------------|---------|-----|------|--|--|
| | | | | -5 | 55 | -7 | ' 0 | -9 | 00 | Unit | | |
| Symbol | Alt | Parameter | Test Condition | V _{CC} = 5 | V ± 5% | | V _{CC} = 5 | V ± 10% | | | | |
| | | | | High Speed Interface | | | | | | | | |
| | | | | Min | Max | Min | Max | Min | Max | | | |
| t _{AVAV} | t _{RC} | Address Valid to Next Address Valid | $\overline{E} = V_{IL}, \overline{G} = V_{IL}$ | 55 | | 70 | | 90 | | ns | | |
| t _{AVQV} | t _{ACC} | Address Valid to Output Valid | $\overline{E} = V_{IL}, \overline{G} = V_{IL}$ | | 55 | | 70 | | 90 | ns | | |
| t _{ELQX} (1) | t_{LZ} | Chip Enable Low to Output Transition | $\overline{G} = V_{IL}$ | 0 | | 0 | | | | ns | | |
| t _{ELQV} (2) | t _{CE} | Chip Enable Low to Output Valid | $\overline{G} = V_{IL}$ | | 55 | | 70 | | 90 | ns | | |
| t _{GLQX} (1) | toLZ | Output Enable Low to Output Transition | E = V _{IL} | 0 | | 0 | | | | ns | | |
| t _{GLQV} (2) | t _{OE} | Output Enable Low to Output Valid | E = V _{IL} | | 20 | | 30 | | 35 | ns | | |
| tehqx | tон | Chip Enable High to Output Transition | $\overline{G} = V_{IL}$ | 0 | | 0 | | | | ns | | |
| t _{EHQZ} (1) | t _{HZ} | Chip Enable High to Output Hi-Z | $\overline{G} = V_{IL}$ | | 15 | | 20 | | 20 | ns | | |
| t _{GHQX} | tон | Output Enable High to Output Transition | E = V _{IL} | 0 | | 0 | | | | ns | | |
| t _{GHQZ} (1) | t _{DF} | Output Enable High to Output Hi-Z | $\overline{E} = V_{IL}$ | | 15 | | 20 | | 20 | ns | | |
| t _{AXQX} | tон | Address Transition to Output Transition | $\overline{E} = V_{IL}, \overline{G} = V_{IL}$ | 0 | | 0 | | | | ns | | |

Chip Erase (CE) Instruction. This instruction uses six write cycles. The Set-up command 80h is written to address 555h on the third cycle after the two Coded cycles. The Chip Erase Confirm command 10h is similarly written on the sixth cycle after another two Coded cycles. If the second command given is not an erase confirm or if the Coded cycles are wrong, the instruction aborts and the device is reset to Read Array. It is not necessary to program the array with 0000h first as the P/E.C. will auto-

matically do this before erasing it to FFFFh. Read operations after the sixth rising edge of \overline{W} or \overline{E} output the Status Register bits. During the execution of the erase by the P/E.C., Data Polling bit DQ7 returns '0', then '1' on completion. The Toggle bits DQ2 and DQ6 toggle during erase operation and stop when erase is completed. After completion the Status Register bit DQ5 returns '1' if there has been an Erase Failure.

Notes: 1. Sampled only, not 100% tested.
2. G may be delayed by up to telov - tolov after the falling edge of E without increasing telov.

Figure 6. Read Mode AC Waveforms

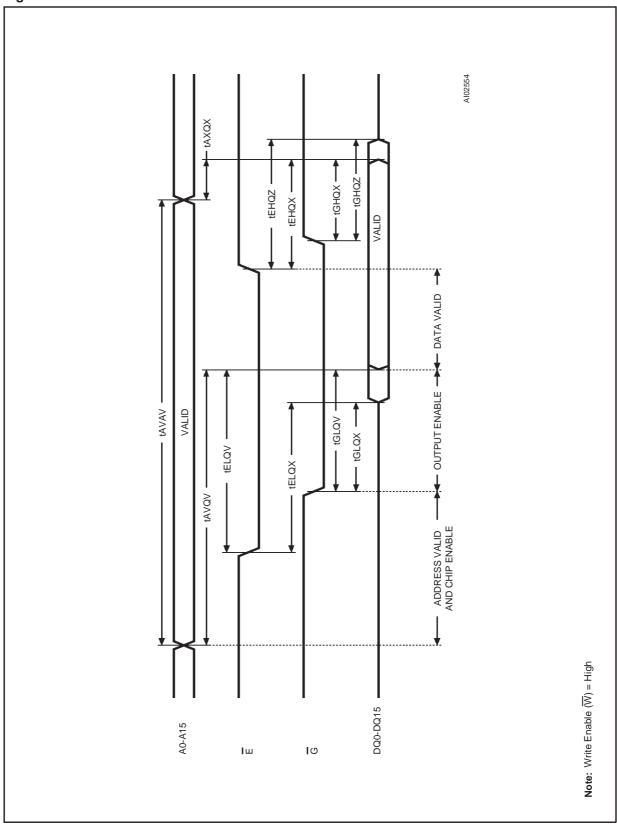


Table 15. Write AC Characteristics, Write Enable Controlled ($T_A = 0$ to 70° C or -40 to 85° C)

| | | | | | M29F | 105B | | | |
|--------------------|------------------|---|---------------------|---------|---------------|---------------------|---------|---------------|----|
| | -55 -70 | 70 | -90 | | Unit | | | | |
| Symbol | Alt | Parameter | V _{CC} = 5 | 5V ± 5% | | V _{CC} = 5 | V ± 10% | |] |
| | | | | | Speed face | | | dard rface | |
| | | | Min | Max | Min | Max | Min | Max | |
| t _{AVAV} | t _{WC} | Address Valid to Next Address Valid | 55 | | 70 | | 90 | | ns |
| t _{ELWL} | t _{CS} | Chip Enable Low to Write Enable Low | 0 | | 0 | | 0 | | ns |
| t _{WLWH} | t _{WP} | Write Enable Low to Write Enable High | 30 | | 35 | | 45 | | ns |
| t _{DVWH} | t _{DS} | Input Valid to Write Enable High | 25 | | 30 | | 45 | | ns |
| t _{WHDX} | t _{DH} | Write Enable High to Input Transition | 0 | | 0 | | 0 | | ns |
| t _{WHEH} | t _{CH} | Write Enable High to Chip Enable High | 0 | | 0 | | 0 | | ns |
| t _{WHWL} | t _{WPH} | Write Enable High to Write Enable Low | 20 | | 20 | | 20 | | ns |
| t _{AVWL} | t _{AS} | Address Valid to Write Enable Low | 0 | | 0 | | 0 | | ns |
| t _{WLAX} | t _{AH} | Write Enable Low to Address Transition | 35 | | 45 | | 45 | | ns |
| t _{GHWL} | | Output Enable High to Write Enable Low | 0 | | 0 | | 0 | | ns |
| t _{VCHEL} | t _{VCS} | V _{CC} High to Chip Enable Low | 50 | | 50 | | 50 | | μs |
| t _{WHGL} | t _{OEH} | Write Enable High to Output Enable Low | 0 | | 0 | | 0 | | ns |

Erase Suspend (ES) Instruction. The Block Erase operation may be suspended by this instruction which consists of writing the command B0h without any specific address. No Coded cycles are required. It permits reading of data from another block and programming in another block while an erase operation is in progress. Erase suspend is accepted only during the Block Erase instruction execution. Writing this command during Erase timeout will, in addition to suspending the erase, terminate the timeout. The Toggle bit DQ6 stops toggling when the P/E.C. is suspended. The Toggle bits will stop toggling between 0.1μs and 15μs after the Erase Suspend (ES) command has been written. The device will then automatically be set to Read Memory Array mode. When erase is sus-

pended, a Read from blocks being erased will output DQ2 toggling and DQ6 at '1'. A Read from a block not being erased returns valid data. During suspension the memory will respond only to the Erase Resume ER and the Program PG instructions. A Program operation can be initiated during erase suspend in one of the blocks not being erased. It will result in both DQ2 and DQ6 toggling when the data is being programmed. A Read/Reset command will definitively abort erasure and result in invalid data in the blocks being erased.

Erase Resume (ER) Instruction. If an Erase Suspend instruction was previously executed, the erase operation may be resumed by giving the command 30h, at any address, and without any Coded cycles.

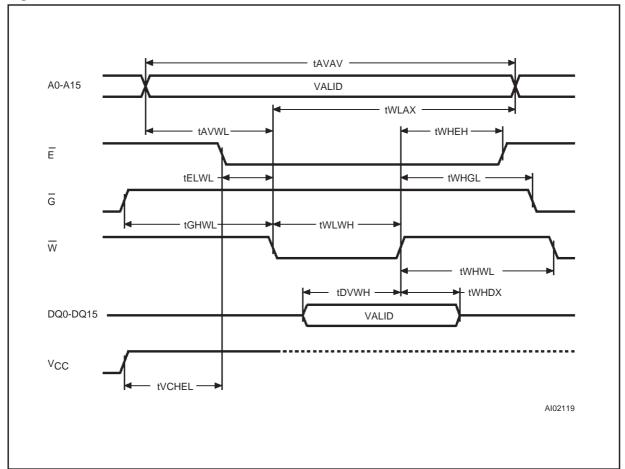


Figure 7. Write AC Waveforms, W Controlled

Note: Address are latched on the falling edge of \overline{W} , Data is latched on the rising edge of \overline{W} .

POWER SUPPLY

Power Up

The memory Command Interface is reset on power up to Read Array. Either \overline{E} or \overline{W} must be tied to V_{IH} during Power Up to allow maximum security and the possibility to write a command on the first rising edge of \overline{E} and \overline{W} . Any write cycle initiation is blocked when Vcc is below V_{LKO} .

Supply Rails

Normal precautions must be taken for supply voltage decoupling; each device in a system should have the V_{CC} rail decoupled with a $0.1\mu F$ capacitor close to the V_{CC} and V_{SS} pins. The PCB trace widths should be sufficient to carry the V_{CC} program and erase currents required.

Table 16. Write AC Characteristics, Chip Enable Controlled (T_A = 0 to 70°C or –40 to 85°C)

| | | | | | M29F | 105B | | | | |
|--------------------|------------------|--|---------------------|--------|-------------------------|------|------|--------------|----|--|
| | | | | 55 | -7 | 70 | | | | |
| Symbol | Alt | Parameter | V _{CC} = 5 | V ± 5% | V_{CC} = 5V \pm 10% | | Unit | | | |
| | | | | | Speed face | | | dard face | | |
| | | | Min | Max | Min | Max | Min | Max | | |
| t _{AVAV} | t _{WC} | Address Valid to Next Address Valid | 55 | | 70 | | 90 | | ns | |
| t _{WLEL} | t _{WS} | Write Enable Low to Chip Enable Low | 0 | | 0 | | 0 | | ns | |
| t _{ELEH} | t _{CP} | Chip Enable Low to Chip Enable High | 30 | | 35 | | 45 | | ns | |
| t _{DVEH} | t _{DS} | Input Valid to Chip Enable High | 25 | | 30 | | 45 | | ns | |
| t _{EHDX} | t _{DH} | Chip Enable High to Input Transition | 0 | | 0 | | 0 | | ns | |
| t _{EHWH} | t _{WH} | Chip Enable High to Write Enable High | 0 | | 0 | | 0 | | ns | |
| t _{EHEL} | t _{CPH} | Chip Enable High to Chip Enable Low | 20 | | 20 | | 20 | | ns | |
| t _{AVEL} | t _{AS} | Address Valid to Chip Enable Low | 0 | | 0 | | 0 | | ns | |
| t _{ELAX} | t _{AH} | Chip Enable Low to Address Transition | 35 | | 45 | | 45 | | ns | |
| t _{GHEL} | | Output Enable High Chip Enable Low | 0 | | 0 | | 0 | | ns | |
| t _{VCHWL} | t _{VCS} | V _{CC} High to Write Enable Low | 50 | | 50 | | 50 | | μs | |
| t _{EHGL} | t _{OEH} | Chip Enable High to Output Enable Low | 0 | | 0 | | 0 | | ns | |

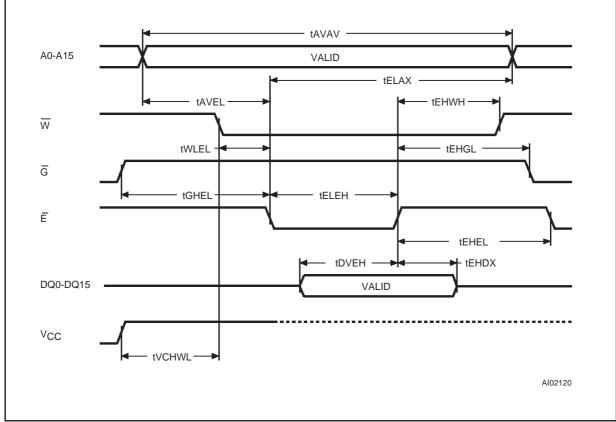


Figure 8. Write AC Waveforms, E Controlled

Note: Address are latched on the falling edge of \overline{E} , Data is latched on the rising edge of \overline{E} .

Table 17. Data Polling and Toggle Bit AC Characteristics $^{(1)}$ $(T_A=0\ to\ 70^{\circ}C\ or\ -40\ to\ 85^{\circ}C)$

| | | | M29F105B | | | | | | |
|--------------------|-----|--|---------------------|-----------------|----------------|-----------------------------|-----------------------|------|------|
| | | | -55 | | -70 | | -90 | |] |
| Symbol | Alt | Parameter | V _{CC} = 5 | V ± 5% | | $V_{\rm CC}$ = 5V \pm 10% | | | Unit |
| | | | | High S Inter | Speed rface | | Standard Interface | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t _{WHQ7V} | | Write Enab <u>le</u> High to DQ7 Valid (Program, W Controlled) | 10 | 2400 | 10 | 2400 | 10 | 2400 | μs |
| WHQ/V | | Write Enable <u>High</u> to DQ7 Valid (Chip Erase, W Controlled) | 1 | 30 | 1 | 30 | 1 | 30 | sec |
| t _{EHQ7V} | | Chip Enable High to DQ7 Valid (Program, E Controlled) | 10 | 2400 | 10 | 2400 | 10 | 2400 | μS |
| EHQ/V | | Chip Enable <u>High</u> to DQ7 Valid (Chip Erase, E Controlled) | 1 | 30 | 1 | 30 | 1 | 30 | sec |
| t _{Q7VQV} | | Q7 Valid to Output Valid (Data Polling) | | 25 | | 30 | | 50 | ns |
| t _{WHQV} | | Write Enable High to Output Valid (Program) | 10 | 2400 | 10 | 2400 | 10 | 2400 | μS |
| WHQV | | Write Enable High to Output Valid (Chip Erase) | 1 | 30 | 1 | 30 | 1 | 30 | sec |
| t _{EHOV} | | Chip Enable High to Output Valid (Program) | 10 | 2400 | 10 | 2400 | 10 | 2400 | μs |
| Engv | | Chip Enable High to Output Valid (Chip Erase) | 1 | 30 | 1 | 30 | 1 | 30 | sec |

Note: 1. All other timings are defined in Read AC Characteristics table.

AI02121 MEMORY —— ARRAYREAD CYCLE VALID VALID DATA OUTPUT VALID ADDRESS (WITHIN BLOCKS) tazvav 🛧 DATA POLLING (LAST) CYCLE IGNORE DQ7 tGLQV ↑ tELQV tWHQ7V tEHQ7V - tAVQV ← LAST WRITE → → → DATA POLLING → OYCLE OF READ CYCLES
PROGRAM
OR ERASE
INSTRUCTION DQ0-DQ6/ DQ8-DQ15 A0-A15 DQ7 I≷ IΦ lш

Figure 9. Data Polling DQ7 AC Waveforms

Figure 10. Data Polling Flowchart

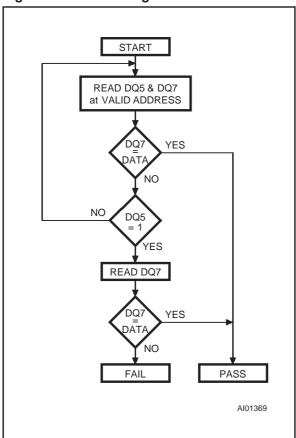


Figure 11. Data Toggle Flowchart

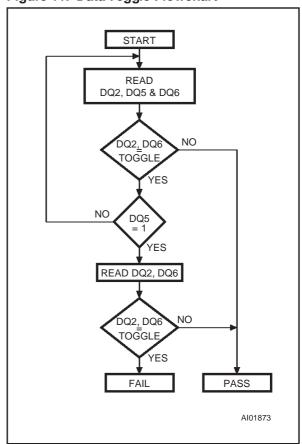


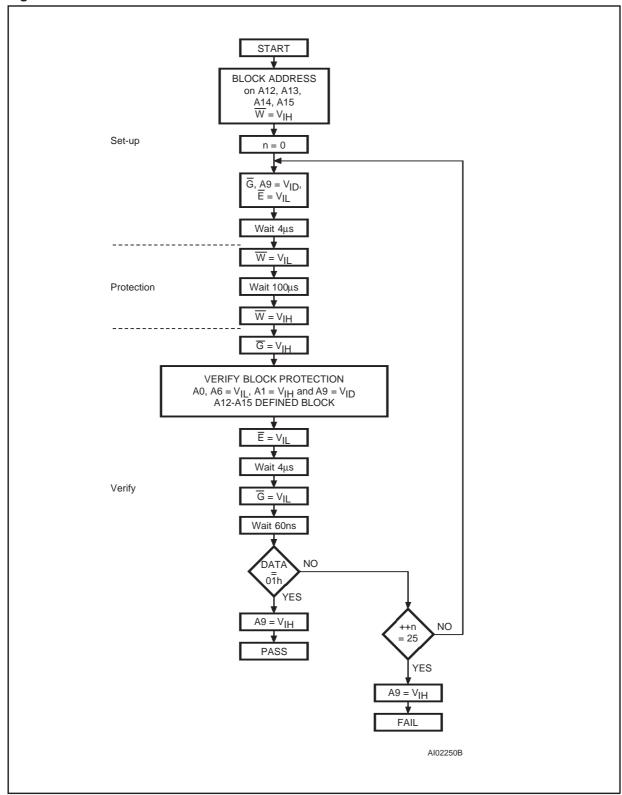
Table 18. Program, Erase Times and Program, Erase Endurance Cycles (T_A = 0 to 70°C; V_{CC} = 5V \pm 10% or 5V \pm 5%)

| Parameter | Min | Тур | Typical after 100k W/E Cycles | Unit |
|----------------------------------|---------|-----|----------------------------------|--------|
| Chip Erase (Preprogrammed) | | 0.4 | 0.6 | sec |
| Chip Erase | | 1.5 | 1.7 | sec |
| Boot Block Erase | | 0.6 | | sec |
| Parameter Block Erase | | 0.5 | | sec |
| Main Block (32Kb) Erase | | 0.9 | | sec |
| Main Block (64Kb) Erase | | 1.0 | | sec |
| Chip Program | | 1.4 | 1.4 | sec |
| Word Program | | 20 | 20 | μs |
| Program/Erase Cycles (per Block) | 100,000 | | | cycles |

AI02122 VALID VALID MEMORY ARRAY
 READ CYCLE ▲ tGLQV - tELQV VALID tAVQV STOP TOGGLE DATA TOGGLE -READ CYCLE IGNORE tWHQV tEHQV — DATA — TOGGLE READ CYCLE Note: All other timings are as a normal Read cycle. LAST WRITE WATCOYCLE OF PROGRAM OF ERASE INSTRUCTION DQ0-DQ1,DQ3-DQ5,DQ7/ DQ8-DQ15 DQ6,DQ2 A0-A15 I≥ Iш IQ

Figure 12. Data Toggle DQ6, DQ2 AC Waveforms

Figure 13. Block Protection Flowchart



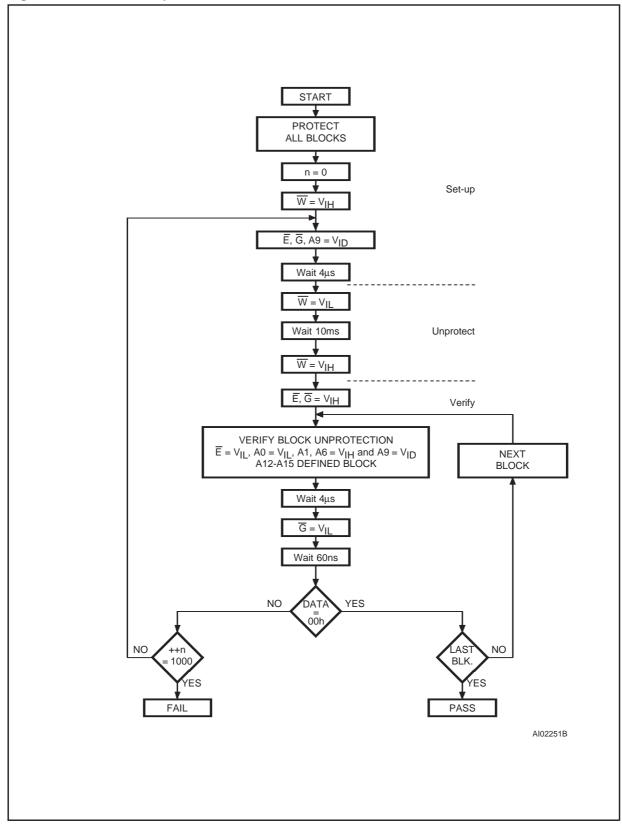


Figure 14. All Blocks Unprotection Flowchart

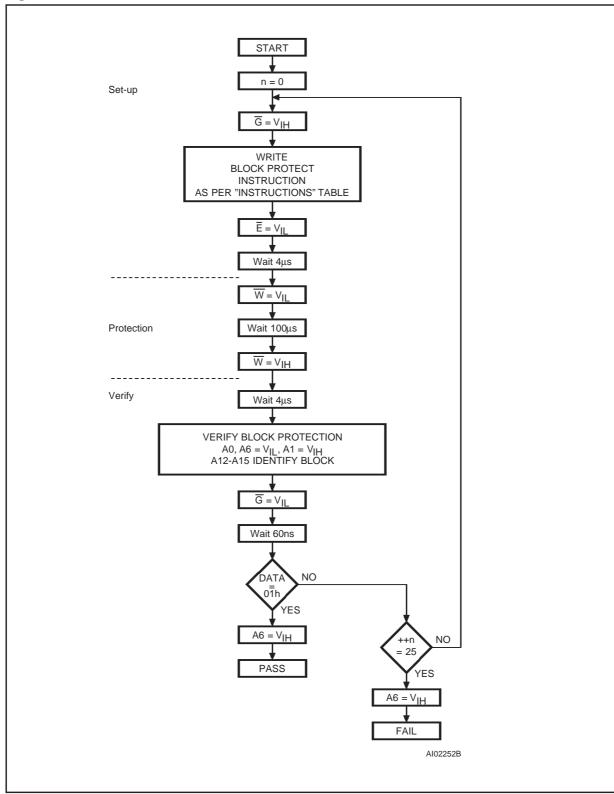


Figure 15. Block Protection Flowchart with BP Instruction

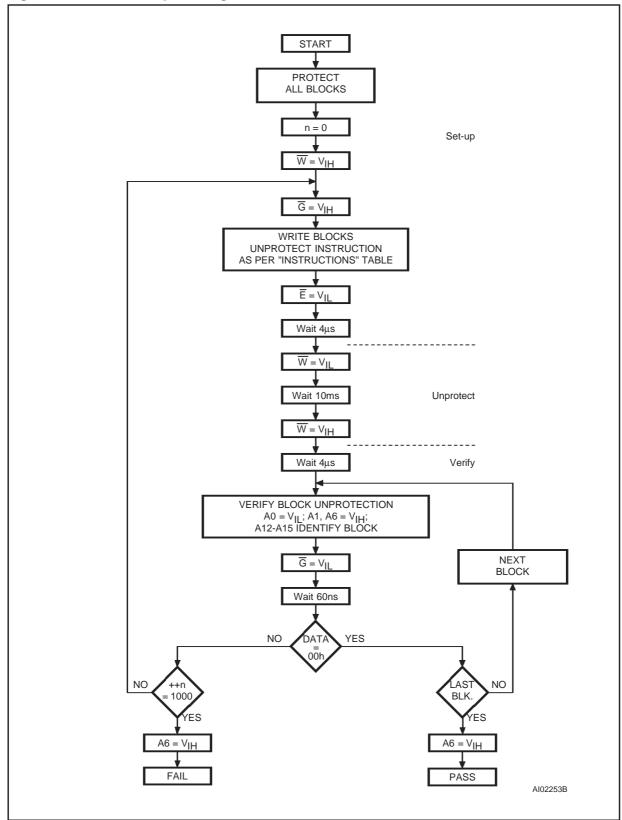
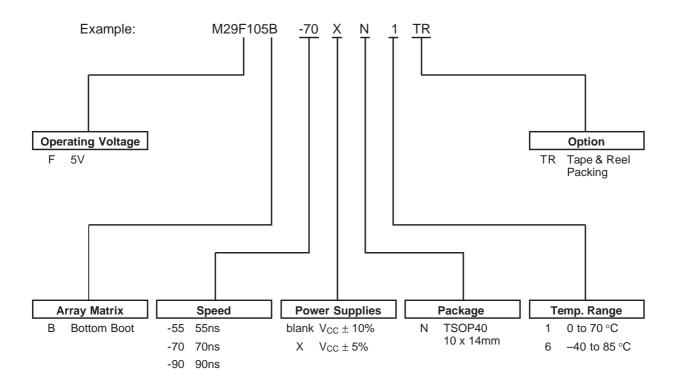


Figure 16. All Blocks Unprotecting Flowchart with BU Instruction

ORDERING INFORMATION SCHEME

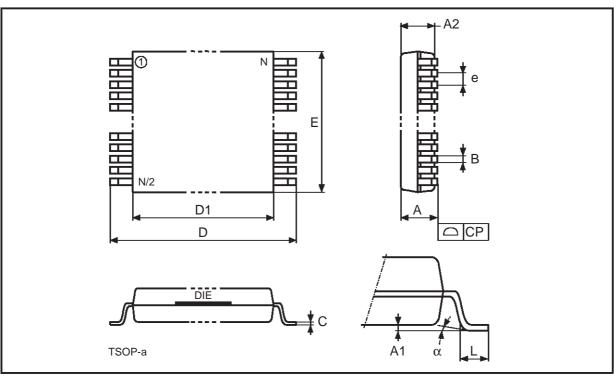


Devices are shipped from the factory with the memory content erased (to FFh).

For a list of available options (Speed, Package, etc...) or for further information on any aspect of this device, please contact the STMicroelectronics Sales Office nearest to you.

TSOP40 - 40 lead Plastic Thin Small Outline, 10 x 14mm

| Symb | | mm | | inches | | |
|--------|------|-------|-------|--------|-------|-------|
| Oyillo | Тур | Min | Max | Тур | Min | Max |
| А | | | 1.20 | | | 0.047 |
| A1 | | 0.05 | 0.15 | | 0.002 | 0.006 |
| A2 | | 0.95 | 1.05 | | 0.037 | 0.041 |
| В | | 0.17 | 0.27 | | 0.007 | 0.011 |
| С | | 0.10 | 0.21 | | 0.004 | 0.008 |
| D | | 13.80 | 14.20 | | 0.543 | 0.559 |
| D1 | | 12.30 | 12.50 | | 0.484 | 0.492 |
| Е | | 9.90 | 10.10 | | 0.390 | 0.398 |
| е | 0.50 | _ | _ | 0.020 | _ | _ |
| L | | 0.50 | 0.70 | | 0.020 | 0.028 |
| α | | 0° | 5° | | 0° | 5° |
| N | | 40 | | | 40 | |
| СР | | | 0.10 | | | 0.004 |



Drawing is not to scale.

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